Applicabl	le standard									
тррпоаві	Operating temperature ran	qe	-40 °C to +85°C (Note1)	Storage temperature ra	ange	-10 °C	to +60	D°C (N	ote3)	
Rating	Operating humidity range		20% to 80% (Note2)	Storage humidity range	)	40% t	o 70%	6 (No	te3)	
	Voltage		100V AC/DC	Applicable connector		DF52#-*P-0.8C				
	Current		2.5 A	Using cable Insulation diam	neter	UL1571 , AWG28 φ 0.58mm				
			Specifica	ations			<del></del>			
Item			Test method	<u>'</u>		Requirements			QT	AT
Construct	ion	I		<u> </u>						
General exa		Visually a	and by measuring instrument.	Accordi	According to drawing.				Χ	Χ
Marking		Confirme	ed visually.						X	X
Electric o	characteristi	ics		<u>'</u>						
		20mV M	AX, 1mA (DC or 1000Hz).	10 mΩ	10 mΩ MAX.				Χ	-
Mechani	cal characte	eristics		•				· ·		
			nsertion and extraction.	0	①Contact resistance: 20 m Ω MAX. ②No damage, crack or looseness of parts.				Χ	-
Vibration			v 10 to 55 Hz, single amplitude at 10 cycles for 3 direction.	-	①No electrical discontinuity of 1 μ s. ②No damage, crack or looseness of parts.				Χ	_
Shock			duration of pulse 11 ms at 3 times each for al directions.		<ul><li>①No electrical discontinuity of 1 μ s.</li><li>②No damage, crack or looseness of parts.</li></ul>				Χ	-
Environm	ental charact	teristics		•		•		ı		
Damp heat		-	at $40 \pm 2^{\circ}$ C, 90 to 95 %, 96 h. ing the room temperature for 1-2h.)	0	①Contact resistance: 20 m Ω MAX. ②No damage, crack or looseness of parts.				Х	-
Rapid change of temperature		Time Under 5 cy (The trans	ure -55°C→ +85°C 30min→ 30min ycles. ferring time of the tank is 2-3 min) ng the room temperature for 1-2h.)	0	①Contact resistance: 20 m Ω MAX. ②No damage, crack or looseness of parts.				X	
Remarks										

Note 1:Including the temperature rising by current.

Note 2:No condensing

Note 3:Apply to the condition of long term storage for unused products before pcb on board,

after pcb on board, operating temperature and humidity range is applied for interim storage during transportation.

	Count	Description of revisions	Designed	Designed		Checked	Date
$\sqrt{2}$	1	DIS-H-00001640	TS. KUMAZAWA	1		TS. FUKUSHIMA	16. 05. 19
				Approved		KI. AKIYAMA	15. 11. 16
					ked	TS. FUKUSHIMA	15. 11. 16
						TS. KUMAZAWA	15. 11. 16
Unless otherwise specified, refer to IEC 60512.					awn MI.SAKIMURA		15. 11. 16
Note	e QT:Qua	t Drawing	Drawing No.		ELC-366938-00-00		
<b>HS</b>		Specification sheet	Part No.	DF52-2832PF1571-28A9-300			9-300 /2
		Hirose electric co., ltd.	Code No.	С	CL668-9001-0-00		